IEC 61169-60

Edition 1.0 2021-03

INTERNATIONAL STANDARD

NORME INTERNATIONALE

Radio-frequency connectors – Part 60: Sectional specification for RF coaxial connectors with push on mating – Characteristic impedance 50 Ohm (type SMPM)

Connecteurs pour fréquences radioélectriques – Partie 60: Spécification intermédiaire relative aux connecteurs coaxiaux pour fréquences radioélectriques avec couplage par poussée – Impédance caractéristique 50 Ohm (type SMPM)

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FOREWORD

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IEC 61169-60 has been prepared by subcommittee 46F: RF and microwave passive components, of IEC technical committee 46: Cables, wires, waveguides, RF connectors, RF and microwave passive components and accessories. It is an International Standard.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
46F/548/FDIS	46F/555/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/standardsdev/publications.

A list of all parts of the IEC 61169 series, under the general title *Radio-frequency connectors*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

RADIO-FREQUENCY CONNECTORS –

Part 60: Sectional specification for RF coaxial connectors with push on mating – Characteristic impedance 50 Ohm (type SMPM)

1 Scope

This part of IEC 61169, which is a sectional specification (SS), provides information and rules for the preparation of detail specifications (DS) for RF coaxial connectors with push-on coupling, typically for use in 50 Ω RF cables or micro-strips in microwave, telecommunication, wireless systems and other fields (SMPM).

It specifies mating face dimensions for general purpose connectors – grade 2, dimensional details of standard test connectors-grade 0, gauging information and tests selected from IEC 61169-1, applicable to all detail specifications relating to series SMPM RF connectors.

This specification indicates recommended performance characteristics to be considered when writing a detail specification and it covers test schedules and inspection requirements for assessment levels M and H.

The SMPM push-on coupling structure series RF coaxial connectors with the characteristic of normative impedance 50 Ω are used with various kinds of RF cables or micro-strips in microwave, telecommunication, wireless systems. The operating frequency limit is up to 65 GHz.

NOTE Imperial dimensions are original dimensions. All undimensioned pictorial configurations are for reference purpose only.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1, *Environmental testing – Part 1: General and guidance*

IEC 61169-1:2013, *Radio frequency connectors – Part 1: Generic specification – General requirements and measuring methods*

IEC 62037 (all parts), *Passive RF and microwave devices, intermodulation level measurement*

3 Terms and definitions

No terms and definitions are listed in this document.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at http://www.electropedia.org/
- ISO Online browsing platform: available at http://www.iso.org/obp

4 Mating face and gauge information

4.1 Dimensions – General connectors – Grade 2

4.1.1 SMPM connector with pin-centre contact

4.1.1.1 SMPM connector with pin-centre contact – Full detent (see Figure 1)

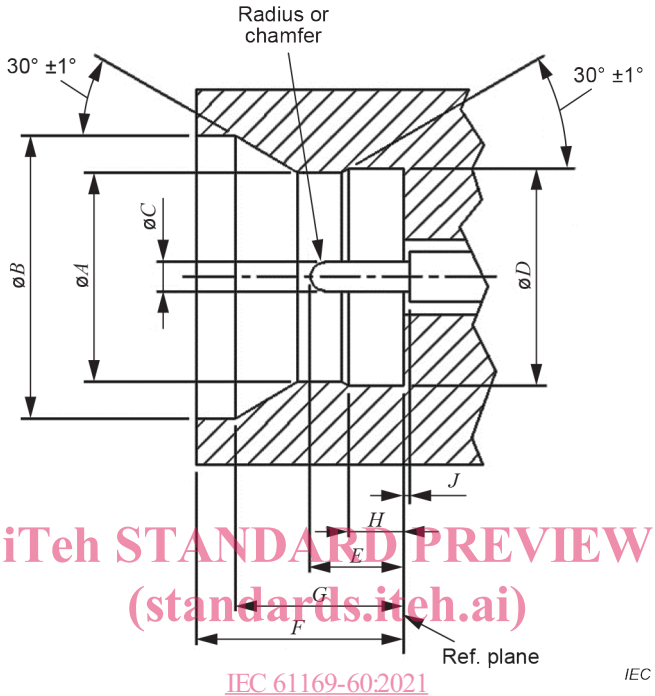


Figure 1 – SMPM connector with pin-centre contact – Full detent (for dimensions, see Table 1)

Table 1 – Dimensions of SMPM connector with pin-centre contact full detent

Ref.	Inches (millimetres)		Remarks
	min	max	
A	0,083 (2,108)	0,085 (2,159)	
B	0,111 (2,819)	0,115 (2,921)	
C	0,0115 (0,292)	0,0125 (0,318)	
D	0,086 (2,184)	0,088 (2,235)	
E	0,030 (0,762)	0,045 (1,143)	
F	0,082 (2,083)	0,084 (2,134)	
G	0,062 (1,575)	0,072 (1,829)	
H	0,021 (0,533)	0,023 (0,584)	
J	0,000 (0,000)		

4.1.1.2 SMPM connector with pin-centre contact – Smooth bore (see Figure 2)

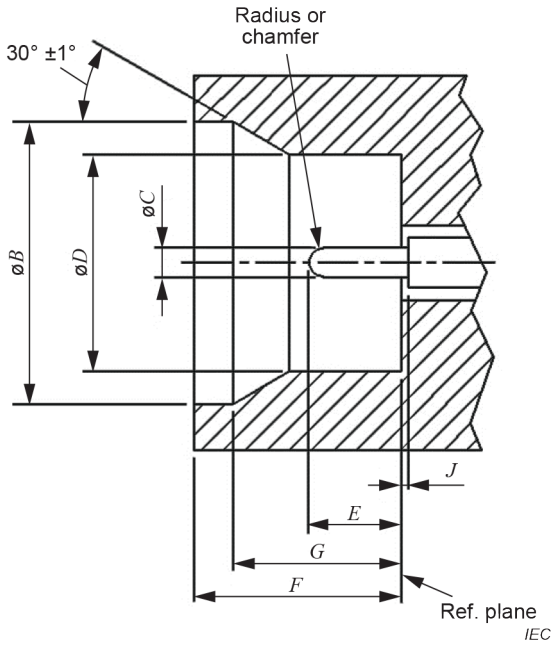
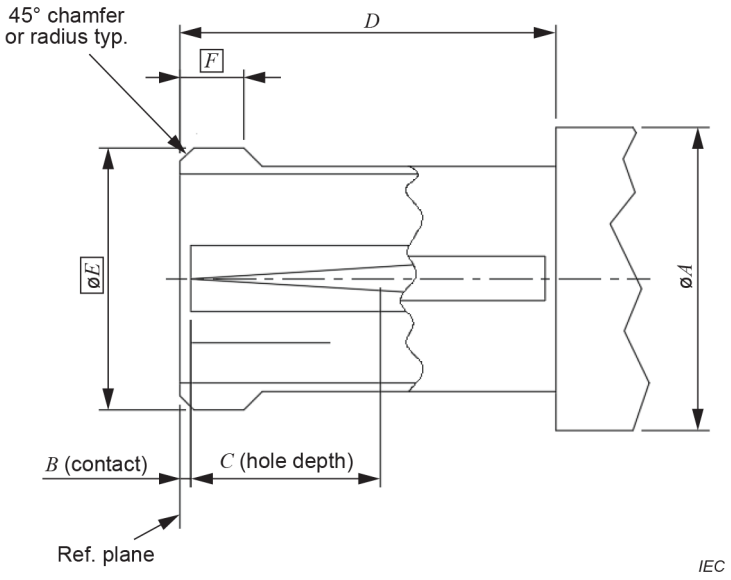


Figure 2 – SMPM connector with pin-centre contact – Smooth bore (for dimensions, see Table 2)

Table 2 – Dimensions of SMPM connector with pin-centre contact – Smooth bore

Ref.	Inches (millimetres)		Remarks
	min	max	
B	0,111 (2,819)	0,115 (2,921)	
C	0,0115 (0,292)	0,0125 (0,318)	
D	0,086 (2,184)	0,088 (2,235)	
E	0,030 (0,762)	0,045 (1,143)	
F	0,082 (2,083)	0,084 (2,134)	
G	0,062 (1,575)	0,072 (1,829)	
J	0,000 (0,000)		

4.1.2 SMPM connector with socket-centre contact (see Figure 3)



Requirements

Features shall meet the mechanical/electrical requirements when mated with connector with pin-centre contact.

Figure 3 – SMPM connector with socket-centre contact (for dimensions, see Table 3)

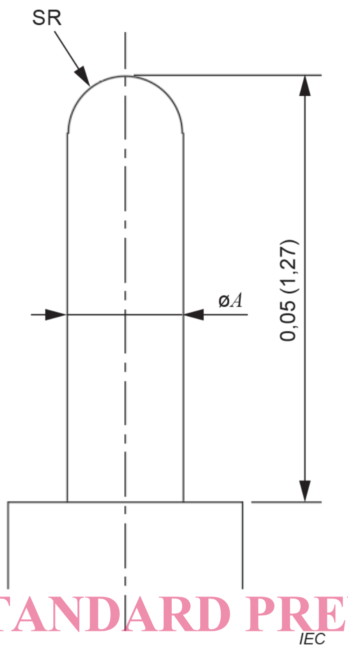
Table 3 – Dimensions of SMPM connector with socket-centre contact

Ref.	Inches (millimetres)		Remarks
	min	max	
A		0,110 (2,794)	
B	0,000 (0,000)	0,008 (0,203)	
C	0,050 (1,270)		
D	0,068 (1,727)		
E		0,095 (2,413)	
F		0,023 (0,584)	

4.2 SMPM gauges

4.2.1 SMPM gauge pin for socket-centre contact

Dimensions in inches (millimetres)



Requirements

1 Material: 440 stainless steel hardness 56 RC to 60 RC.

2 All surfaces shall be Ra 32 microinches (0,8 µm) maximum except the mating surfaces Ø*A* and spherical radius shall be Ra 16 microinches (0,4 µm) maximum.

Figure 4 – SMPM gauge pin for socket-centre contact (for dimensions, see Table 4)

Table 4 – Dimensions of SMPM gauge pin for socket-centre contact

Ref.	Gauge A – Oversize		Gauge B – Insertion force		Gauge C – Retention force	
	Inches (millimetres)		Inches (millimetres)		Inches (millimetres)	
	min	max	min	max	min	max
A	0,0130 (0,330)	0,0131 (0,333)	0,0125 (0,318)	0,0126 (0,320)	0,0114 (0,290)	0,0115 (0,292)

4.2.1.1 Test procedure

4.2.1.1.1 Insertion force

Figure 4 oversize gauge A shall be inserted into the socket-centre contact 3 times to a depth of 0,030 inch (0,762 mm) to 0,045 inch (1,143 mm).

Figure 4 insertion force gauge B shall be inserted into the socket-centre contact to a depth of 0,030 inch (0,762 mm) to 0,045 inch (1,143 mm). The insertion force measured shall be 24 oz. (6,67 N) maximum.

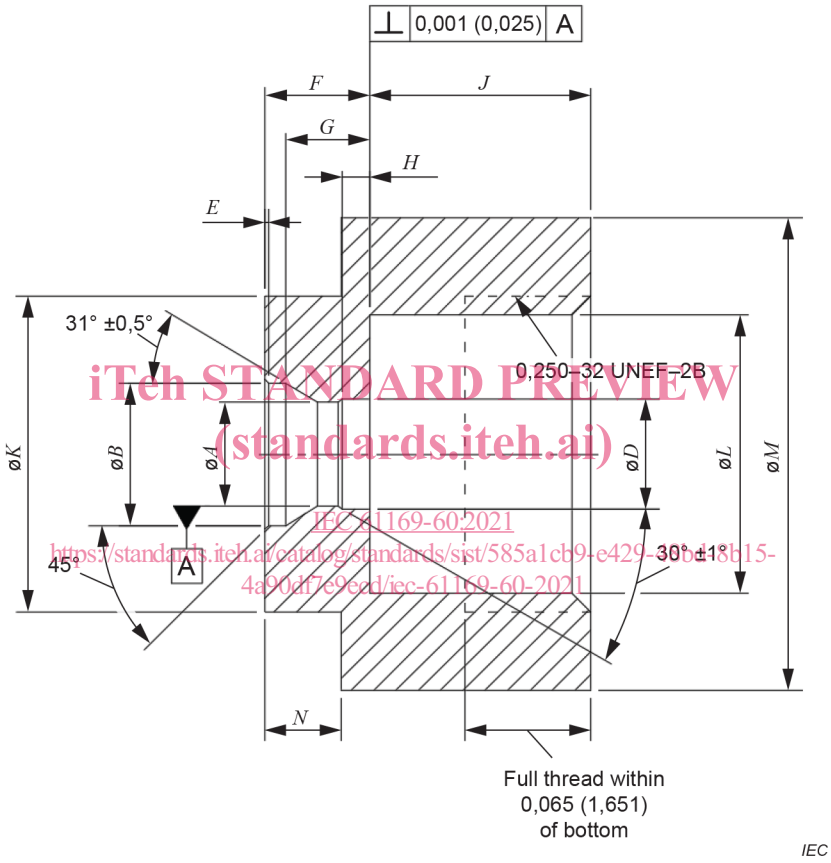
4.2.1.1.2 Retention force

Figure 4 retention force gauge C shall be inserted into the socket-centre contact to a depth of 0,030 inch (0,762 mm) to 0,045 inch (1,143 mm). The retention (withdrawal) force shall be 0,25 oz. (0,07 N) minimum.

4.2.2 Gauges for outer contact of SMPM connector with socket-centre contact

4.2.2.1 Engagement force gauge – Full detent for outer contact of SMPM connector with socket-centre

Dimensions in inches (millimetres)



Requirements

1 Material – 440 stainless steel hardness 56-60 RC.

2 Break corners and edges 0,127 mm (0,005 inches) R. Max. Except ø*D* feature shall be 0,025 mm (0,001 inches) R. Max.

3 Remove all burrs.

4 All diameters concentric to datum A within 0,025 mm (0,001 inches) T.I.R.

5 All surfaces shall be Ra 0,8 µm (32 microinches) maximum except the mating surfaces 31° ±0,5°, øA, 30° ±1° and ø*D* shall be Ra 0,4 µm (16 microinches) maximum.

6 Chamfer first thread

7 No lubricant allowed

Figure 5 – SMPM engagement force gauge – Full detent (for dimensions, see Table 5)

Table 5 – Dimensions of SMPM engagement force gauge – Full detent

Ref.	Inches (millimetres)		Remarks
	min	max	
A	0,0829 (2,106)	0,0831 (2,111)	
B	0,111 (2,819)	0,115 (2,921)	
D	0,086 (2,184)	0,088 (2,235)	
E	0,002 (0,051)	0,004 (0,102)	
F	0,082 (2,083)	0,084 (2,134)	
G	0,062 (1,575)	0,072 (1,829)	
H	0,021 (0,533)	0,023 (0,584)	
J	0,170 (4,318)	0,180 (4,572)	
K	0,245 (6,223)	0,255 (6,477)	
L	0,217 (5,512)	0,223 (5,664)	
M	0,370 (9,398)	0,380 (9,652)	
N	0,055 (1,397)	0,065 (1,651)	

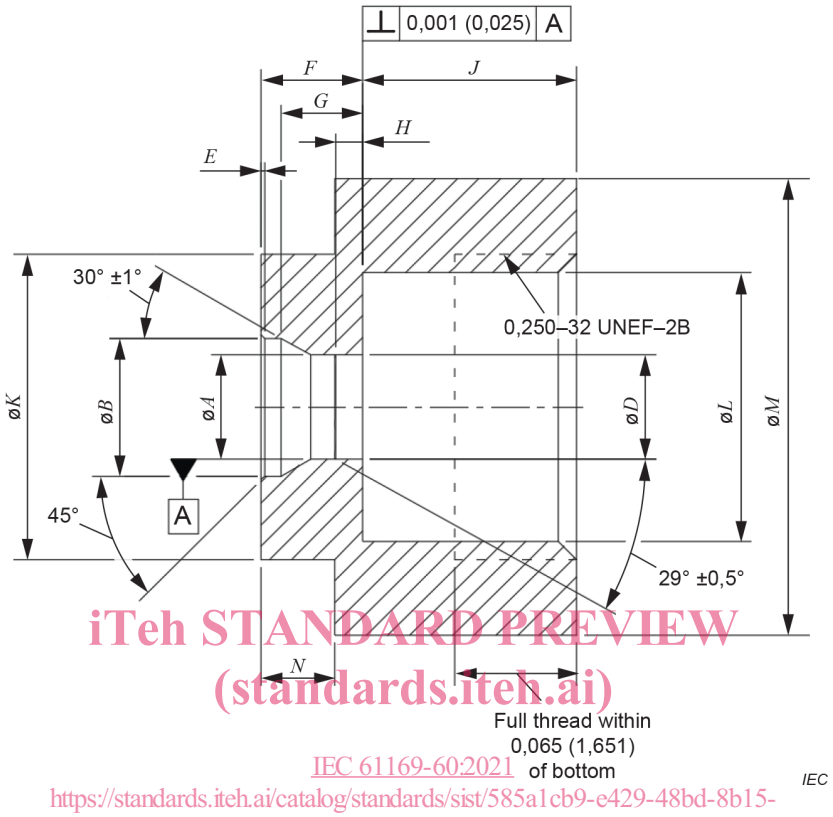
4.2.2.2 Test procedure

The force gauge shall be threaded onto the Figure 9 SMPM Gauge Block and torqued sufficiently to prevent loosening of the thread during force measurement.

Figure 5 engagement force gauge – Full detent shall be fully mated 5 times with the outer contact of the connector. The engagement force shall be measured on the insertion of the fifth mating cycle. The engagement force shall be 8 lbs. (35,59 N) maximum.

4.2.2.3 Separation force gauge – Full detent for outer contact of SMPM connector with socket-centre

Dimensions in inches (millimetres)



Requirements

1 Material – 440 stainless steel hardness 56-60 RC.

2 Break corners and edges 0,127 mm (0,005 inches) R. Max. Except ø*D* feature shall be 0,025 mm (0,001 inches) R. Max.

3 Remove all burrs.

4 All diameters concentric to datum A within 0,025 mm (0,001 inches) T.I.R.

5 All surfaces shall be Ra 0,8 µm (32 microinches) maximum except the mating surfaces 30° ±1°, øA, 29° ±0,5° and ø*D* shall be Ra 0,4 µm (16 microinches) maximum.

6 Chamfer first thread

7 No lubricant allowed

Figure 6 – SMPM Separation force gauge – Full detent (for dimensions, see Table 6)